



Product Change Notification

Change Notification #: 827510-00

Change Title: Intel® Wi-Fi 7 BE202, 1216, 2x2 BE+BT, No vPro,
PCN 827510-00, Manufacturing Site, Label,
Addition of manufacturing site and label updates

Date of Publication: July 18, 2024

Key Characteristics of the Change:

Manufacturing Site, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	December 27, 2024
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Description of Change to the Customer:

The Intel® Wi-Fi 7 BE202 1216 SKU listed in the product affected table below will undergo the following changes:

1. To improve manufacturing flexibility, an existing manufacturing site in Vietnam is being added.
 - a. No impact expected to supply availability.
 - b. Form, fit, function will be identical to existing modules with no MM# or regulatory changes.
 - c. Updated manufacturing location printed on the labels.
2. Add the New Zealand R-NZ compliance marking on the Disti label.
3. Update Japan Giteki MIC logo on the Disti label.
4. Update Oman TRA product marking on the Disti label.
5. Update Singapore IMDA's compliance marking on the Disti label.
6. Product TA# dash up.

BE202.D2WG.NV Disti Label (Before)

BE202.D2WG.NV VERSION #: N29053-002 MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	MM #: XXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS 	QTY: 1000 1 88334 00140 2 9 310779 300005	Intel® Wi-Fi 7 BE202 (Model: BE200D2W M) PKG ID (3S) VVVVMMMMDDDD#####XXXXXX1000 	CE, UK, CA, R-NZ, FCC, IC, CCAH23Y1049B70, 005-230204, D230106003, Intel Corporation, 2200 Mission College Blvd, Santa Clara, CA 95054-1549, USA, www.intel.com, R-C-INT-BE200D2W
			T P/N: GDM48000273 D P/N: XXXXXX REV AXX HP P/N: XXXXXX-XXX REV: XX 	

BE202.D2WG.NV Disti Label (China)

BE202.D2WG.NV VERSION #: N29053-003 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	MM #: XXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS 	QTY: 1000 1 88334 00140 2 9 310779 300005	Intel® Wi-Fi 7 BE202 (Model: BE200D2W M) PKG ID (3S) VVVVMMMMDDDD#####XXXXXX1000 	CE, UK, CA, R-NZ, FCC, IC, CCAH23Y1049B70, 005-230204, D230106003, Intel Corporation, 2200 Mission College Blvd, Santa Clara, CA 95054-1549, USA, www.intel.com, R-C-INT-BE200D2W
			T P/N: GDM48000273 D P/N: XXXXXX REV AXX HP P/N: XXXXXX-XXX REV: XX 	

BE202.D2WG.NV Disti Label (Vietnam)

BE202.D2WG.NV VERSION #: N29053-003 MADE IN VIETNAM WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	MM #: XXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS 	QTY: 1000 1 88334 00140 2 9 310779 300005	Intel® Wi-Fi 7 BE202 (Model: BE200D2W M) PKG ID (3S) VVVVMMMMDDDD#####XXXXXX1000 	CE, UK, CA, R-NZ, FCC, IC, CCAH23Y1049B70, 005-230204, D230106003, Intel Corporation, 2200 Mission College Blvd, Santa Clara, CA 95054-1549, USA, www.intel.com, R-C-INT-BE200D2W
			T P/N: GDM48000273 D P/N: XXXXXX REV AXX HP P/N: XXXXXX-XXX REV: XX 	

BE202.D2WG.NV Reel Label (Before)



BE202.D2WG.NV Reel Label (After)



Customer Impact of Change and Recommended Action:

The manufacturing site and label changes to the product do not affect functionality.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Wi-Fi 7 BE202, 1216, 2x2 BE+BT, No vPro	BE202.D2WG.NV	99C9ZJ	N29053-002	N29053-003

PCN Revision History:

Date of Revision: July 18, 2024	Revision Number: 00	Reason: Originally Published PCN
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Product Change Notification

827510-00

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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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